

JC 4/956

JC971 U.S. PTO

09/885232



Class	Subclass
ISSUE CLASSIFICATION	

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PATENT NUMBER

**U.S. UTILITY Patent Application**

H.H.	O.I.P.E.	PATENT DATE
SCANNED	AG 3.0A	SW

APPLICATION NO. 09/885232	CONT/PRIOR D	CLASS 205	SUBCLASS 108	ART UNIT 1741	EXAMINER Nicolas
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APPLICANTS

Linlin Chen

TITLE

Apparatus and method for electrolytically depositing copper on a semiconductor workpiece

PTO-2040  
1259

**ISSUING CLASSIFICATION**

ORIGINAL		CROSS REFERENCE(S)					
CLASS	SUBCLASS	CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)				
INTERNATIONAL CLASSIFICATION							

☐ Continued on Issue Slip Inside File Jacket

<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>  <input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.  <input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent No. _____  <input type="checkbox"/> The terminal _____ months of this patent have been disclaimed.	<b>DRAWINGS</b> Sheets Drwg. Figs. Drwg. Print Fig.			<b>CLAIMS ALLOWED</b> Total Claims Print Claim for O.G.	
	(Assistant Examiner) (Date)			<b>NOTICE OF ALLOWANCE MAILED</b>	
	(Primary Examiner) (Date)			<b>ISSUE FEE</b> Amount Due Date Paid	
(Legal Instruments Examiner) (Date)			<b>ISSUE BATCH NUMBER</b>		

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